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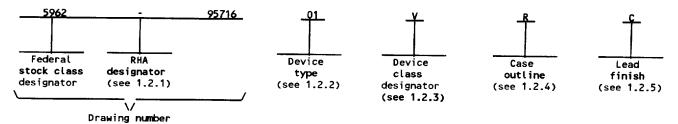
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#### SCOPE

- 1.1 <u>Scope</u>. This drawing forms a part of a one part one part number documentation system (see 6.6 herein). Two product assurance classes consisting of military high reliability (device classes Q and M) and space application (device class V), and a choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). Device class M microcircuits represent non-JAN class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices". When available, a choice of Radiation Hardness Assurance (RHA) levels are reflected in the PIN.
  - 1.2 PIN. The PIN shall be as shown in the following example:



- 1.2.1 <u>RHA designator</u>. Device class M RHA marked devices shall meet the MIL-I-38535 appendix A specified RHA levels and shall be marked with the appropriate RHA designator. Device classes Q and V RHA marked devices shall meet the MIL-I-38535 specified RHA levels and shall be marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.
  - 1.2.2 <u>Device type(s)</u>. The device type(s) shall identify the circuit function as follows:

Device type Generic number Circuit function

01 82C82/7 Latchup resistant CMOS octal latching bus driver

1.2.3 <u>Device class designator</u>. The device class designator shall be a single letter identifying the product assurance level as follows:

Device class

Device requirements documentation

М

Vendor self-certification to the requirements for non-JAN class B microcircuits in accordance with 1.2.1 of MIL-STD-883

Q or V

Certification and qualification to MIL-I-38535

1.2.4 <u>Case outline(s)</u>. The case outline(s) shall be as designated in MIL-STD-1835 and as follows:

Outline letter	<u>Descriptive designator</u>	<u>Terminals</u>	Package style
R	CD I P 2 - T 2 0	20	Dual-in-line package

1.2.5 <u>Lead finish</u>. The lead finish shall be as specified in MIL-STD-883 (see 3.1 herein) for class M or MIL-I-38535 for classes Q and V. Finish letter "X" shall not be marked on the microcircuit or its packaging. The "X" designation is for use in specifications when lead finishes A, B, and C are considered acceptable and interchangeable without preference.

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1.3 Absolute maximum ratings. 1/							
Supply voltage ( $V_{CC}$ )		+8.0 V dc GND -0.5 V dc to V <sub>CC</sub> +0.5 V -65°C to +150°C 12°C/W 68°C/W 0.73 W +175°C +300°C	dc				
1.4 Recommended operating conditions.							
Operating supply voltage range ( $V_{DD}$ ) Operating temperature range ( $V_{IL}$ )		4.5 V dc to +5.5 V dc -55°C to +125°C 0 V dc to +0.8 V dc 2.2 V dc to VDD					
2. APPLICABLE DOCUMENTS							
2.1 Government specification, standards, bulletin, and has specification, standards, bulletin, and handbook of the iss of Specifications and Standards specified in the solicitatinerein.	ue listed in	that issue of the Department	of Defense Index				
SPECIFICATION							
MILITARY							
MIL-1-38535 - Integrated Circuits, Manufacturing,	General Speci	fication for.					
STANDARDS							
MILITARY							
MIL-STD-883 - Test Methods and Procedures for Microelectronics. MIL-STD-973 - Configuration Management. MIL-STD-1835 - Microcircuit Case Outlines.							
BULLETIN							
MILITARY							
MIL-BUL-103 - List of Standardized Military Drawin	gs (SMD's).						
HANDBOOK							
MILITARY							
MIL-HDBK-780 - Standardized Military Drawings.							
(Copies of the specification, standards, bulletin, and hand acquisition functions should be obtained from the contracti	ng activity o	r as directed by the contract	ting activity.)				
2.2 <u>Order of precedence</u> . In the event of a conflict between the text of this drawing shall take precedence.	ween the text	of this drawing and the refe	rences cited				
Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability. If device power exceeds package dissipation capability, provide heat sinking or derate linearly (the derating is based on \(\theta_{JA}\)) at the rate of 14.7 mM/°C.							
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### 3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements for device class M shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein. The individual item requirements for device classes Q and V shall be in accordance with MIL-I-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as described herein.
- 3.2 <u>Design. construction. and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-STD-883 (see 3.1 herein) for device class M and MIL-I-38535 for device classes Q and V and herein.
  - 3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein.
  - 3.2.2 <u>Ierminal connections</u>. The terminal connections shall be as specified on figure 1.
  - 3.2.3 Block diagram. The block diagram shall be as specified on figure 2.
  - 3.2.4 <u>liming waveforms</u>. The timing waveforms shall be as specified in figure 3.
- 3.3 <u>Electrical performance characteristics and postirradiation parameter limits</u>. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table IIA. The electrical tests for each subgroup are defined in table I.
- 3.5 <u>Marking</u>. The part shall be marked with the PIN listed in 1.2 herein. Marking for device class M shall be in accordance with MIL-STD-883 (see 3.1 herein). In addition, the manufacturer's PIN may also be marked as listed in MIL-BUL-103. Marking for device classes Q and V shall be in accordance with MIL-I-38535.
- 3.5.1 <u>Certification/compliance mark</u>. The compliance mark for device class M shall be a "C" as required in MIL-STD-883 (see 3.1 herein). The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-I-38535.
- 3.6 <u>Certificate of compliance</u>. For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.7.2 herein). For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.7.1 herein). The certificate of compliance submitted to DESC-EC prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device class M, the requirements of MIL-STD-883 (see 3.1 herein), or for device classes Q and V, the requirements of MIL-I-38535 and the requirements herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required for device class M in MIL-STD-883 (see 3.1 herein) or for device classes Q and V in MIL-I-38535 shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 Notification of change for device class M. For device class M, notification to DESC-EC of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-STD-973.
- 3.9 <u>Verification and review for device class M</u>. For device class M, DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
- 3.10 <u>Microcircuit group assignment for device class M</u>. Device class M devices covered by this drawing shall be in microcircuit group number 105 (see MIL-I-38535, appendix A).

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Test	Symbol	Conditions -55°C ≤ T <sub>A</sub> ≤ +125°C	Group A subgroups	Device type	L	imits	Unit
		-55°C < T <sub>A</sub> < +125°C unless otherwise specified 1/	d		Min	Max	
Logical "1" input voltage	v <sub>I H</sub>	V <sub>CC</sub> = 5.5 V <u>2</u> / <u>3</u> / Pins 1-8,9,11	1,2,3	All	2.2		v
Logical "0" input voltage	V <sub>IL</sub>	V <sub>CC</sub> = 4.5 V <u>3</u> / Pins 1-8,9,11	1,2,3	All		0.8	٧
Output HIGH voltage	V <sub>OH1</sub>	V <sub>CC</sub> = 4.5 V, <del>OE</del> = GND <u>4</u> / I <sub>OH</sub> = -8.0 mA, Pins 12-19	1,2,3	ALL	2.9		v
	v <sub>OH2</sub>	V <sub>CC</sub> = 4.5 V, <del>OE</del> = GND 4/ I <sub>OH</sub> = -100 μA, Pins 12-19			v <sub>cc</sub> -0.4		
Output LOW voltage	v <sub>OL</sub>	V <sub>CC</sub> = 4.5 V, OE = GND 4/ I <sub>OL</sub> = +8.0 mA, Pins 12-19	1,2,3	ALL		0.4	v
Input leakage current	I I H	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = GND or V Pins 1-9, 11	cc 1,2,3	All	-1.0	1.0	μА
Output leakage current	I <sub>OZL</sub>	$V_{CC} = 5.5 \text{ V}, \overline{OE} > = V_{CC-0.5}$ $V_{OUT} = GND \text{ or } V_{CC}$ PINS 12-19	V 1,2,3	All	-10	10	μΑ
Standby power supply current	I CCSB	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = GND or V Outputs open	DD 1,2,3	All		10.0	μΑ
Input capacitance	c <sub>IN</sub>	V <sub>CC</sub> = Open, f = 1 MHz All measurements referenced	4	All		13	pF
Output capacitance	<sup>С</sup> оит	to GND See 4.4.1c	4	All	:	20	pF
Functional tests		See 4.4.1b V <sub>CC</sub> = 4.5 V and 5.5 V <u>5</u> /	7,8	All			
TIMING REQUIREMENTS							•
Propagation delay, input to output	<sup>t</sup> īvov	V <sub>CC</sub> = 4.5 V <u>6</u> / <u>7</u> /	9,10,11	All		40	ns
Propagation delay, STB to output	<sup>t</sup> sHOV		9,10,11	All		55	ns
See footnotes at end	of table.		•		•		
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Test	Symbol	Conditions <u>1</u> / -55°C ≤ T <sub>A</sub> ≤ +125°C	Group A subgroups	Device type	Limits		Unit
		unless otherwise specified			Min	Max	
TIMING REQUIREMENTS	- CONTINU	ED.				•	
Output enable time	tELOV	V <sub>CC</sub> = 4.5 V <u>6</u> / <u>7</u> /	9,10,11	All		50	ns
Input to STB setup time	tIVSL	-	9,10,11	ALL	0		ns
nput to STB hold time	t <sub>SLIX</sub>	-	9,10,11	All	25		ns
TB high time	t <sub>SHSL</sub>		9,10,11	All	25		ns
utput disable time	<sup>t</sup> EHOZ	8/ 9/	9,10,11	ALL		40	ns
nput rise/fall time	t <sub>R</sub> t <sub>F</sub>	<u>8</u> /	9,10,11	ALL		20	ns

Interchanging of force and sense conditions is permitted. f = 1 MHz,  $V_{IH} = 2.6 \text{ V}$  ( $V_{IH}$  for STB > =  $V_{CC}$ -0.5 V),  $V_{IL} = 0.4 \text{ V}$ ,  $C_{L} = 50 \text{ pF}$ ,  $V_{OH} = 1.5 \text{ V}$ ,  $V_{OL} = 1.5 \text{ V}$ . All ac parameter tested as per test load circuits and definitions on figures 4. Input rise and fall times are driven at 1 V/ns.

Unless otherwise specified, test as follows: f = 1 MHz,  $V_{IH} = 2.6 \text{ V}(V_{IH} \text{ for STB}) = V_{CC}^{-0.5}$ ,  $V_{IL} = 0.4 \text{ V}$ .  $C_L = 50 \text{ pF } V_{OH} > = 1.5 \text{ V}$ ,  $V_{OL} < = 1.5 \text{ V}$ ,  $V_{CC} = 4.5$ . The parameters listed are controlled via design of process parameters and are not directly listed.

These parameters are characterized upon intial design and after major process and/or design changes.

Unless otherwise specified, test as follows: f = 1 MHz,  $V_{IH} = 2.6 \text{ V}(V_{IH} \text{ for STB}) = V_{CC}^{-0.5}$ ,  $V_{IL} = 0.4 \text{ V}$ .  $C_L = 50 \text{ pF}$   $V_{OH} > = 1.5 \text{ V}$ ,  $V_{OL} < = 1.5 \text{ V}$ ,  $V_{CC} = 4.5$ . and 5.5 V.

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Device typ	e					
Case outline						
Terminal number	Terminal symbol					
1	010					
2	DI <sub>1</sub>					
3	DI <sub>2</sub>					
4	D13					
5	DI <sub>4</sub>					
6	DI <sub>5</sub>					
7	DI6					
8	017					
9	OE OE					
10	GND					
11	STB					
12	D0 <sub>7</sub>					
13	D06					
14	D0 <sub>5</sub>					
15	D0 <sub>4</sub>					
16	D03					
17	002					
18	DO <sub>1</sub>					
19	000					
20	v <sub>cc</sub>					

FIGURE 1. <u>Ierminal connections</u>.

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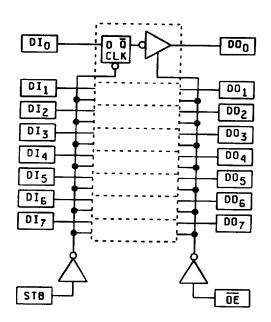


FIGURE 2. Block diagram.

STB	0 E	DI	DO
x	Н	×	HI-Z
н	L	L	L
н	L	н	Н
1	L	×	*

H = Logic 1

L = Logic 0

X = Don't care

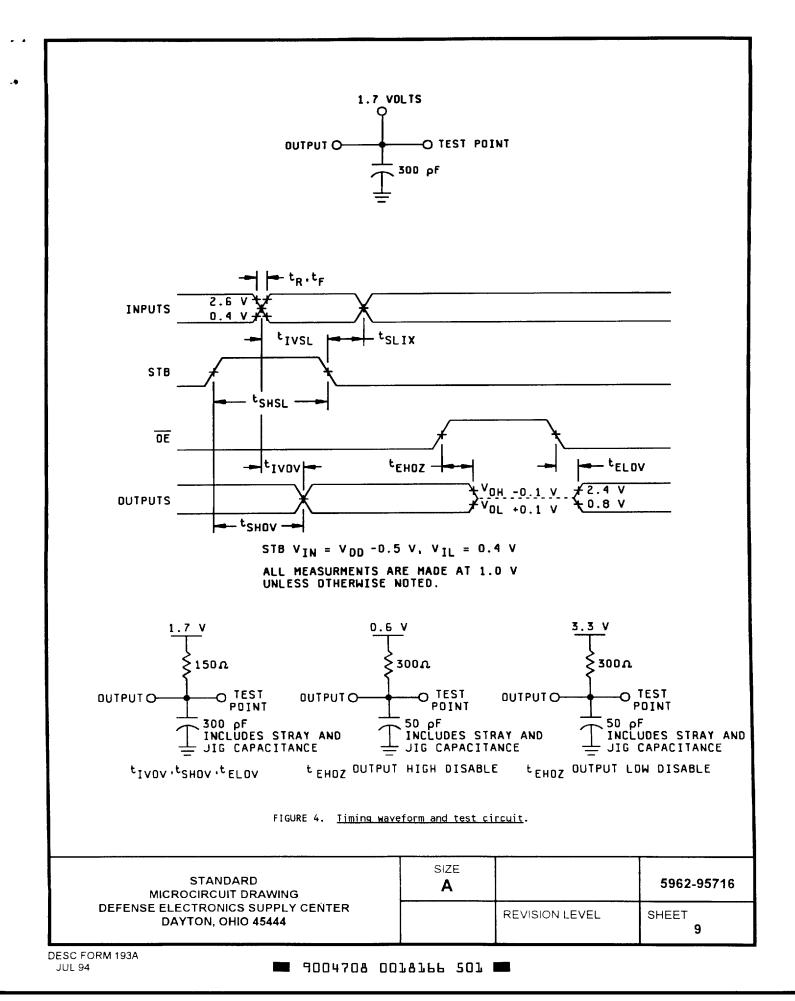
HI-Z = High Impedance

1 = Neg. transition
\* = latched to value of last data

Figure 3. <u>Iruth table</u>

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- 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. For device class M, sampling and inspection procedures shall be in accordance with MIL-STD-883 (see 3.1 herein). For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-I-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as described herein.
- 4.2 <u>Screening</u>. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. For device classes Q and V, screening shall be in accordance with MIL-1-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection.
  - 4.2.1 Additional criteria for device class M.
    - a. Burn-in test, method 1015 of MIL-STD-883.
      - (1) Test condition A, B, C or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
      - (2)  $T_A = +125 \, \text{C}$ , minimum.
  - b. Interim and final electrical test parameters shall be as specified in table IIA herein.
  - 4.2.2 Additional criteria for device classes Q and V.
    - a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-I-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
    - b. Interim and final electrical test parameters shall be as specified in table IIA herein.
    - c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in appendix B of MIL-I-38535, or as modified in the device manufacturers approved Quality Management (QM) plan.
- 4.3 <u>Qualification inspection for device classes Q and V</u>. Qualification inspection for device classes Q and V shall be in accordance with MIL-I-38535. Inspections to be performed shall be those specified in MIL-I-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).
- 4.4 <u>Conformance inspection</u>. Quality conformance inspection for device class M shall be in accordance with MIL-STD-883 (see 3.1 herein) and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4). Technology conformance inspection for classes Q and V shall be in accordance with MIL-I-38535, or as specified in the QM plan, including groups A, B, C, D, and E inspections and as specified herein except where option 2 of MIL-I-38535 permits alternate in-line control testing.
  - 4.4.1 Group A inspection.
    - a. Tests shall be as specified in table IIA herein.
    - b. For device class M, subgroups 7 and 8 tests shall be sufficient to verify the functionality of the device. For device classes Q and V, subgroups 7 and 8 shall include verifying the functionality of the device.
    - c. Subgroup 4 (C<sub>IN</sub>, C<sub>OUT</sub> measurement) shall be measured only for the initial test and after process or design changes which may affect capacitance. A minimum sample size of 5 devices with zero rejects shall be required.
- 4.4.2 <u>Group C inspection</u>. The group C inspection end-point electrical parameters shall be as specified in table II herein.

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TABLE IIA. <u>Electrical test requirements</u>.

Subgroups (in accordance with MIL-STD-883, TM 5005, table 1)	Subgroups (in accordance with MIL-I-38535, table III)		
Device class M	Device class Q	Device class V	
1,7,9	1,7,9	1,7,9	
1,2,3,7,8,9, <u>1</u> / 10,11	1,2,3,7,8, <u>1</u> / 9,10,11	1,2,3,7,8,2/ 9,10,11 <u>3</u> /	
1,2,3,4,7,8,9 10,11	1,2,3,4,7,8, 9,10,11	1,2,3,4,7, 8,9,10,11	
1,2,3,7,8,9 10,11	1,2,3,7,8,9 10,11	1,2,3,7,8,9 10,11 <u>3</u> /	
1,7,9	1,7,9	1,7,9	
1,7,9	1,7,9	1,7,9	
	(in accordance with MIL-STD-883, TM 5005. table 1)  Device class M  1,7,9  1,2,3,7,8,9, 1/10,11  1,2,3,4,7,8,9 10,11  1,2,3,7,8,9 10,11	(in accordance with MIL-STD-883, TM 5005. table 1)  Device class M  1,7,9  1,2,3,7,8,9, 1/10,11  1,2,3,4,7,8,9 10,11  1,2,3,7,8,9 10,11  1,2,3,7,8,9 10,11  1,2,3,7,8,9 10,11  1,2,3,7,8,9 10,11  1,2,3,7,8,9 10,11  1,7,9  1,7,9	

- 1/ PDA applies to subgroup 1 and 7.
- 2/ PDA applies to subgroups 1,7 and delta's.
  3/ Delta limits as specified in Table IIB herein shall be required where specified and the delta values shall be completed with reference to the zero hour electrical parameters (See Table I).

Table IIB. Delta Limits

Parameter	Symbol	Delta limits	
Standby power supply current	ICCSB	+/- 2.0 µA	
Output leakage current	IOZL, IOZH	+/- 2.0 μA	
Input leakage current	IIH,IIL	+/- 200 nA	

# 4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883.

- a. Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005.
- b.  $T_A = +125$ °C, minimum.
- c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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- 4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB, in accordance with MIL-I-38535, and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005.
- 4.4.3 <u>Group D inspection</u>. The group D inspection end-point electrical parameters shall be as specified in table IIA herein.
- 4.4.4 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein). RHA levels for device classes Q and V shall be M, D, L, R, F, G, and H and for device class M shall be M and D.
  - a. End-point electrical parameters shall be as specified in table IIA herein.
  - b. For device class M, the devices shall be subjected to radiation hardness assured tests as specified in MIL-I-38535, appendix A, for the RHA level being tested. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-I-38535 for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at I<sub>A</sub> = +25°C ±5°C, after exposure, to the subgroups specified in table IIA herein.
  - c. When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied.

### 5. PACKAGING

- 5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-STD-883 (see 3.1 herein) for device class M and MIL-I-38535 for device classes Q and V.
  - 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
  - 6.1.2 <u>Substitutability</u>. Device class Q devices will replace device class M devices.
- 6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.
- 6.3 <u>Record of users</u>. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and which SMD's are applicable to that system. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DESC-EC, telephone (513) 296-6047.
- 6.4 <u>Comments</u>. Comments on this drawing should be directed to DESC-EC, Dayton, Ohio 45444-5270, or telephone (513) 296-5377.
- 6.5 <u>Abbreviations. symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-I-38535 and MIL-STD-1331.

STANDARD
MICROCIRCUIT DRAWING
DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO 45444

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DESC FORM 193A JUL 94 6.6 One part - one part number system. The one part - one part number system described below has been developed to allow for transitions between identical generic devices covered by the three major microcircuit requirements documents (MIL-H-38534, MIL-I-38535, and 1.2.1 of MIL-STD-883) without the necessity for the generation of unique PIN's. The three military requirements documents represent different class levels, and previously when a device manufacturer upgraded military product from one class level to another, the benefits of the upgraded product were unavailable to the Original Equipment Manufacturer (OEM), that was contractually locked into the original unique PIN. By establishing a one part number system covering all three documents, the OEM can acquire to the highest class level available for a given generic device to meet system needs without modifying the original contract parts selection criteria.

Military documentation format	Example PIN under new system	Manufacturing source listing	Document <u>listing</u>
New MIL-H-38534 Standard Microcircuit Drawings	5962-XXXXXZZ(H or K)YY	QML-38534	MIL-BUL-103
New MIL-1-38535 Standard Microcircuit Drawings	5962-XXXXXZZ(Q or V)YY	QML - 38535	MIL-BUL-103
New 1.2.1 of MIL-STD-883 Standard Microcircuit Drawings	5962-XXXXXZZ(M)YY	MIL-BUL-103	MIL-BUL-103

## 6.7 Sources of supply.

- 6.7.1 <u>Sources of supply for device classes Q and V</u>. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DESC-EC and have agreed to this drawing.
- 6.7.2 <u>Approved sources of supply for device class M</u>. Approved sources of supply for class M are listed in MIL-BUL-103. The vendors listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-EC.

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